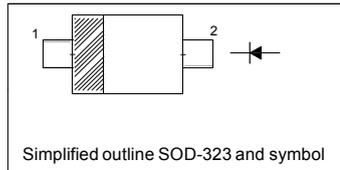


Surface Mount Schottky Barrier Diodes

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode


MARKING: 76
Absolute Maximum Ratings ($T_a = 25\text{ }^\circ\text{C}$)

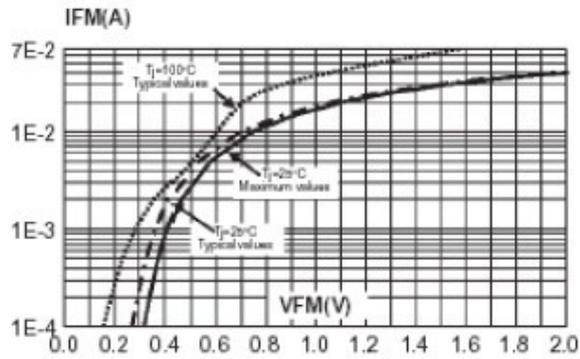
Parameter	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	70	V
Continuous Forward Current	I_F	70	mA
Surge Non-Repetitive Forward Current ($t_p = 10\text{ ms}$)	I_{FSM}	1	A
Total Power Dissipation	P_{tot}	230	mW
Thermal Resistance Junction to Ambient ¹⁾	R_{thJA}	550	$^\circ\text{C/W}$
Junction Temperature	T_J	150	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	- 65 to + 150	$^\circ\text{C}$

¹⁾ Mounted on epoxy board, with recommended pad layout.

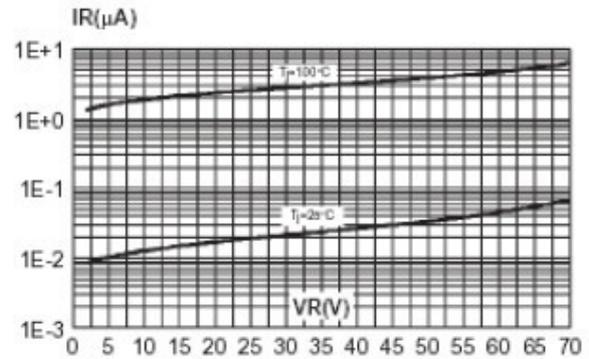
Characteristics at $T_a = 25\text{ }^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 10\text{ }\mu\text{A}$	V_{BR}	70	-	V
Forward Voltage at $I_F = 1\text{ mA}$	V_F	-	410	mV
Reverse Current at $V_R = 50\text{ V}$	I_R	-	100	nA
Diode Capacitance at $V_R = 0\text{ V}$, $f = 1\text{ MHz}$	C_{tot}	-	2	pF

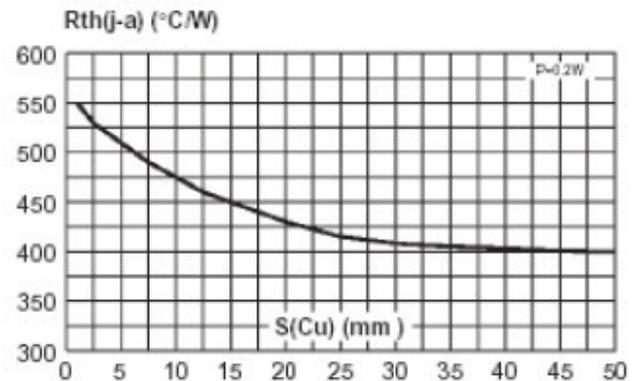
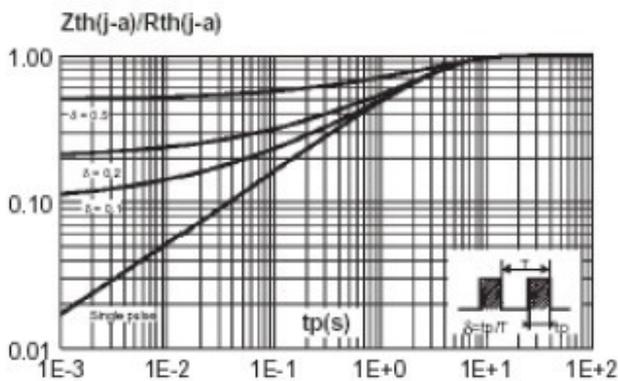
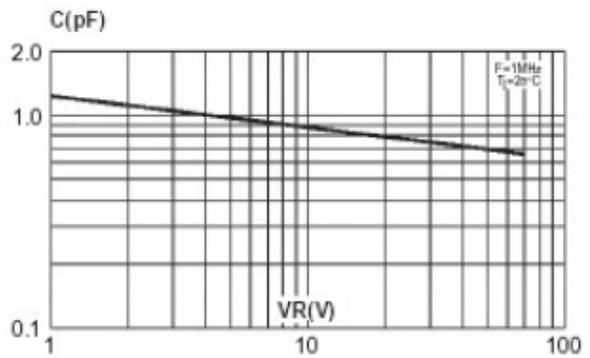
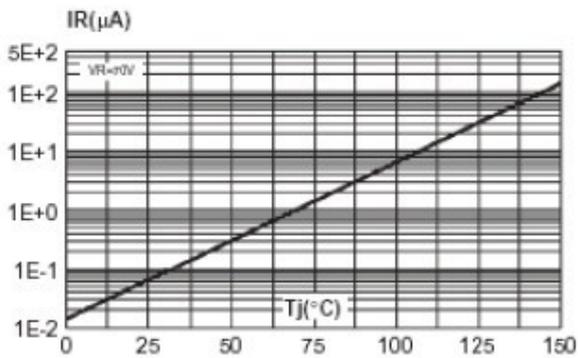
Typical Characteristics



Reverse leakage current versus junction temperature (typical values).

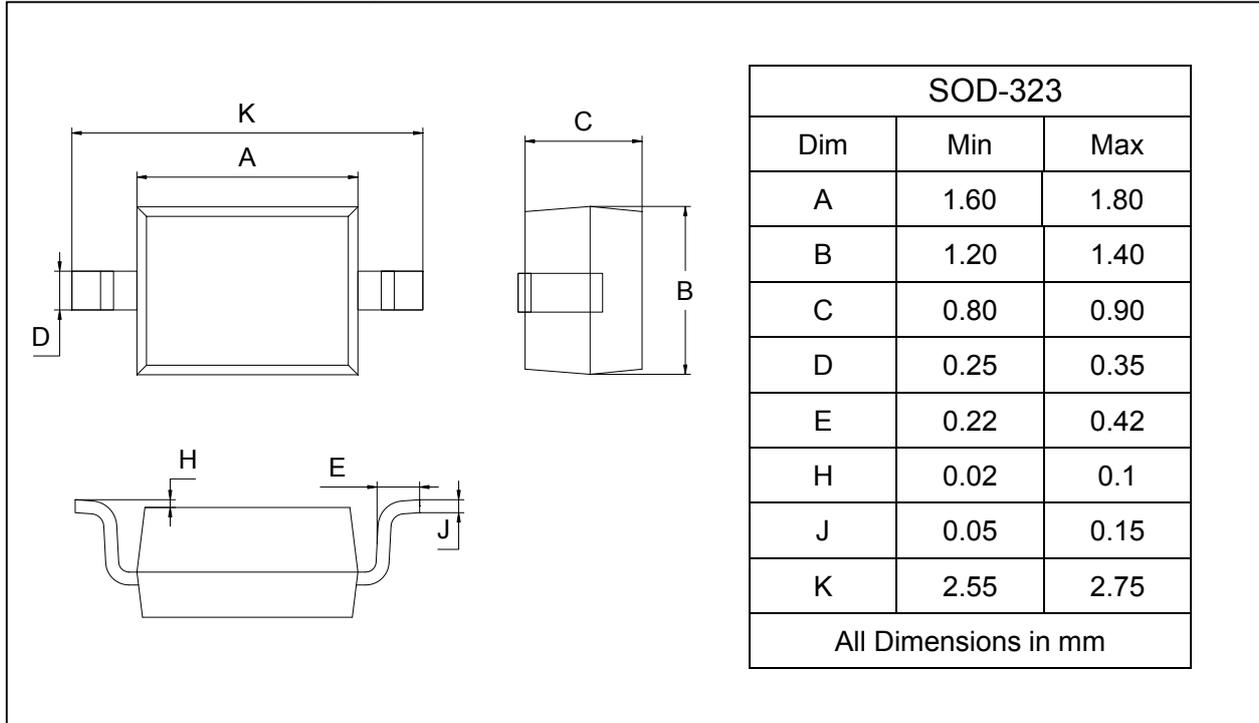


Junction capacitance versus reverse voltage applied (typical values).

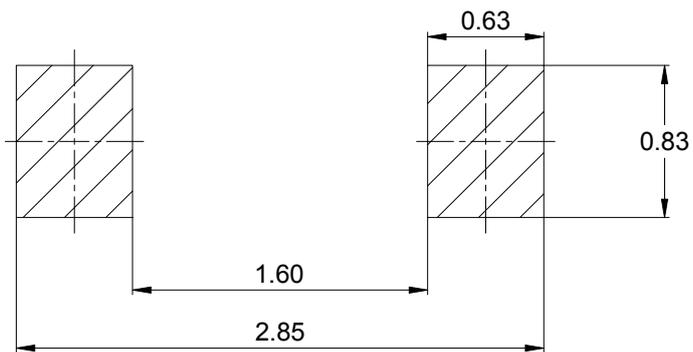


Plastic surface mounted package

SOD-323



SOLDERING FOOTPRINT



Unit : mm